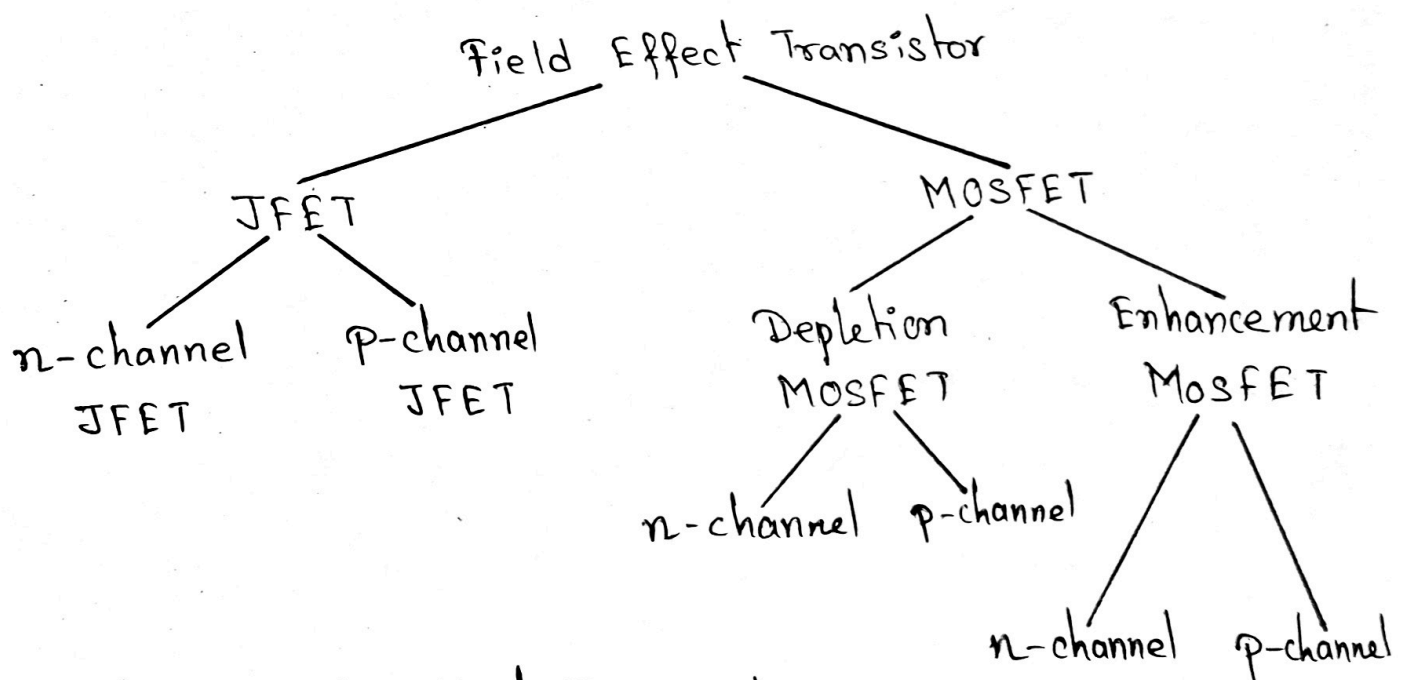


• Field Effect Transistors (FET):

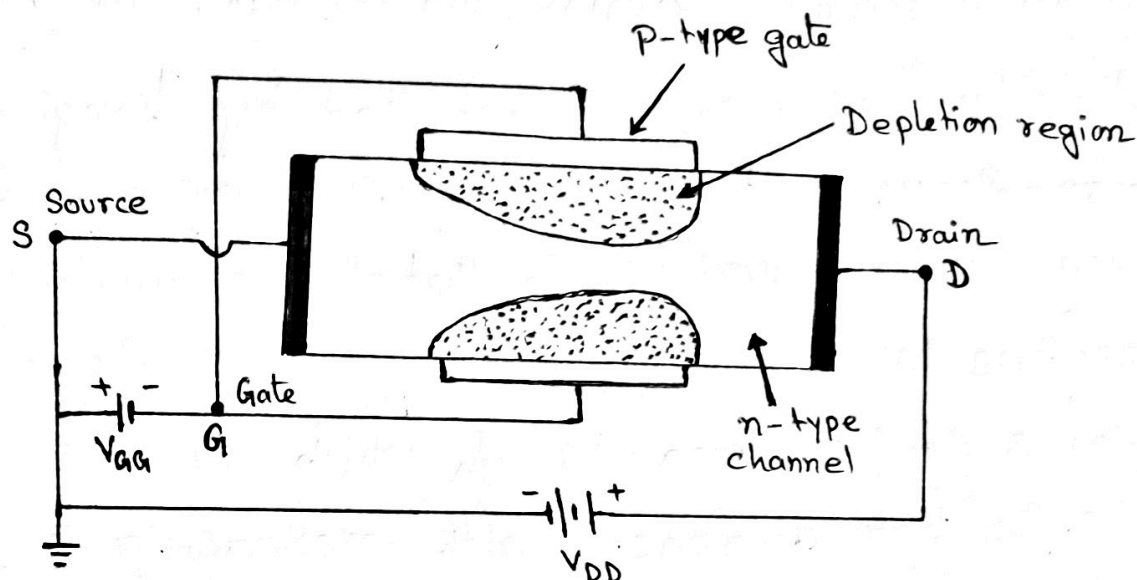
- The field-effect transistor (FET) is a ~~an~~ semiconductor device with the output current controlled by an electric field.
- In FET the current is carried predominantly by one type of carriers, thus the FET is known as unipolar transistor.
- The FET is thus different from the bipolar junction transistor (BJT) which involves two types of carriers (electrons and holes) for current conduction.
- FET are used in controlled switching between conducting and nonconducting states in a digital circuits. FETs are also thermally stable.



Junction Field-Effect Transistor (JFET):

The JFET consists of a uniformly doped semiconductor base usually of Silicon (Si) or Gallium

arsenide (GaAs). If the semiconductor bar is n-type, the JFET is called n-channel JFET, on the other hand if the bar is p-type, the device is termed a p-channel JFET.



Basic structure of JFET

Two sides of the bar are heavily doped with impurities opposite to that of the bar. (i.e. p-type impurities for an n-type bar and n-type impurities for an p-type bar). By applying a voltage V_{DD} between the two ends of the bar a current is allowed to flow along the length of the bar.

Source (S): The terminal through which the majority carriers enter the bar is known as source.

Drain (D): The terminal through which the majority carriers leave the bar is known as drain.

Gate (G): The region on the two sides of the bar heavily doped with impurities opposite to the bar is called Gate.

Principle of JFET Operation :

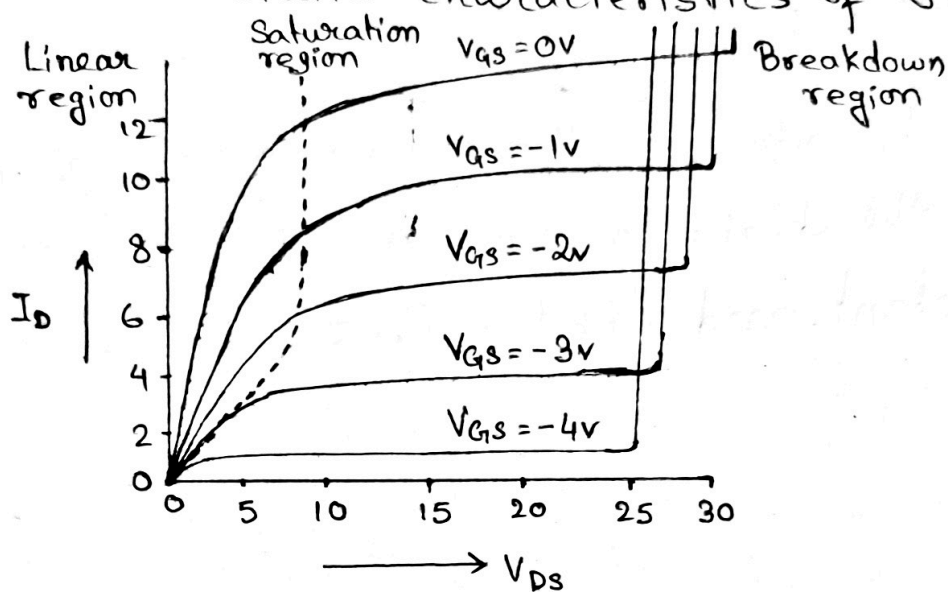
The junction between the bar and the gate is reverse biased by applying a voltage V_{GG} . The resulting depletion regions extend into the bar. The width of the depletion region can be controlled by changing the gate-to-Source voltage. The depletion region does not have any current carriers, so that the conductivity of these regions is nominally zero. Therefore, the effective cross sectional area through which the current flows in the bar decreases with increasing reverse bias. For a given drain-to-Source voltage, the drain current is a function of the gate-to-Source voltage.

The JFET is basically a voltage-controlled resistor, the resistance being controlled by the gate voltage.

The portion of the Semiconductor bar between the depletion region through which the majority carriers move from source to drain is called the channel.

Static Characteristics of JFET:

The graphical plots of the drain current (I_D) against the drain-to-source voltage (V_{DS}) with the gate-to-source voltage (V_{GS}) as a parameter are known as static characteristics of JFET.



The drain characteristics are found to consist of three regions,

- The linear region, where the voltage V_{DS} is small and I_D is nearly proportional to V_{DS} .
- The saturation region where I_D is fairly constant and is independent of V_{DS} .
- The breakdown region where I_D increases rapidly with a small increase of V_{DS} .

The constant drain current in the saturation region of the characteristics is called the saturation current (I_{Dsat}). The minimum value of V_{DS} at which

the drain current saturates for a given V_{GS} is called the saturation voltage V_{DSat} . The points of intersection of the dashed curve with the characteristics give the values of I_{DSat} and V_{DSat} for different V_{GS} .

Pinch off voltage:

Pinch off voltage is the drain to source voltage after which the drain to source current becomes almost constant and JFET enters into saturation region.